Unit: mm

TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type

SSM3J108TU

High Speed Switching Applications

• 1.8V drive

• Low on-resistance: $R_{on} = 363 \text{m}\Omega \text{ (max) (@V_{GS} = -1.8 V)}$

 R_{on} = 230m Ω (max) (@V_{GS} = -2.5 V)

 $R_{on} = 158m\Omega \text{ (max) } (@V_{GS} = -4.0 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-Source voltage		V_{DS}	-20	V	
Gate-Source voltage		V_{GSS}	± 8	V	
Drain current	DC	I _D	-1.8	А	
	Pulse	I_{DP}	-3.6		
Drain power dissipation		P _D (Note 1)	800	mW	
		P _D (Note 2)	500		
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	−55~150	°C	

Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on ceramic board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 0.8 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$

Note 2: Mounted on FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$

2-2U1A

Weight: 6.6 mg (typ.)

JEDEC

JEITA

TOSHIBA

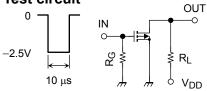
Electrical Characteristics (Ta = 25°C)

Characte	eristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-20	_	_	V
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = +8 \text{ V}$	-12	_	—	ľ
Drain cut-off current	t	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0$	_	_	-10	μА
Gate leakage currer	nt	I _{GSS}	$V_{GS} = \pm 8V$, $V_{DS} = 0$	_	_	±1	μА
Gate threshold volta	age	V _{th}	$V_{DS} = -3 \text{ V}, I_D = -1 \text{ mA}$	-0.3	_	-1.0	V
Forward transfer ad	mittance	Y _{fs}	$V_{DS} = -3 \text{ V}, I_{D} = -0.8 \text{ A}$ (Note3)	1.9	3.2	_	S
Drain-Source on-resistance		R _{DS} (ON)	$I_D = -0.8 \text{ A}, V_{GS} = -4.0 \text{ V}$ (Note3)	· —	125	158	mΩ
			$I_D = -0.4 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note3)	_	170	230	
			$I_D = -0.1 \text{ A}, V_{GS} = -1.8 \text{ V}$ (Note3)	_	230	363	
Input capacitance		C _{iss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	250	_	pF
Output capacitance		Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	45	_	pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	35	_	pF
Switching time	Turn-on time	t _{on}	$V_{DD} = -10 \text{ V}, I_D = -0.25 \text{ A},$ $V_{GS} = 0 \sim -2.5 \text{ V}, R_G = 4.7 \Omega$	_	12	_	ns
	Turn-off time	t _{off}		_	18	_	
Drain-Source forward voltage		V _{DSF}	$I_D = 1.8A, V_{GS} = 0 V$ (Note3)	_	0.85	1.2	V

Note3: Pulse test

Switching Time Test Circuit





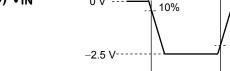
 $V_{DD} = -10 \text{ V}$ $R_G = 4.7 \Omega$

D.U. ≦ 1% V_{IN} : t_r , $t_f < 5$ ns

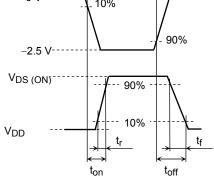
Common Source

 $Ta = 25^{\circ}C$

(b) V_{IN}

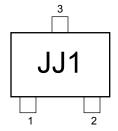


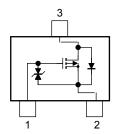
(c) Vout



Marking

Equivalent Circuit (top view)





Precaution

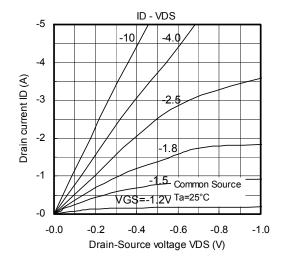
Vth can be expressed as the voltage between gate and source when the low operating current value is I_D=-1mA for this product. For normal switching operation, VGS (on) requires a higher voltage than Vth, and VGS (off) requires a lower voltage than V_{th.}

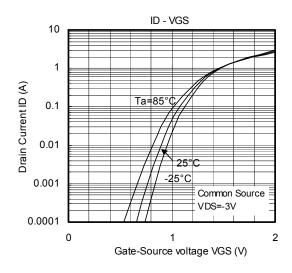
(The relationship can be established as follows: $V_{GS (off)} < V_{th} < V_{GS (on)}$)

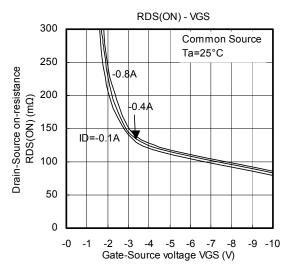
Take this into consideration when using the device.

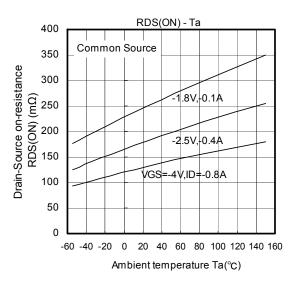
Handling Precaution

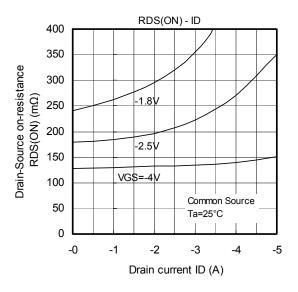
When handling individual devices which are not yet mounted on a circuit board, be sure that the environment is protected against electrostatic discharge. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

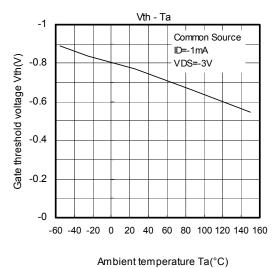




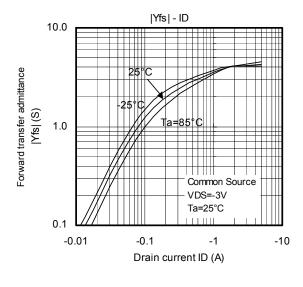


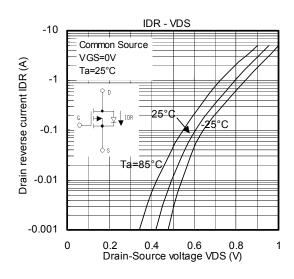


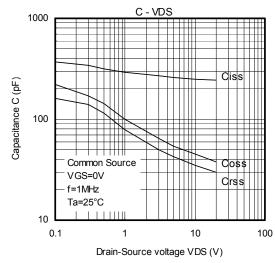


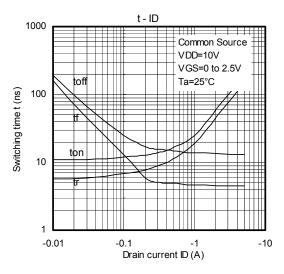


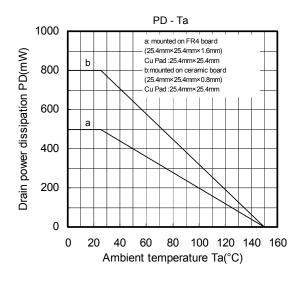
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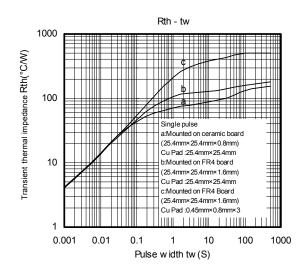












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20070701-EN GENERAL

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